

DXT2011P5Q

100V NPN MEDIUM POWER LOW SATURATION TRANSISTOR

Description

This Bipolar Junction Transistor (BJT) is designed to meet the stringent requirement of Automotive Applications

Features

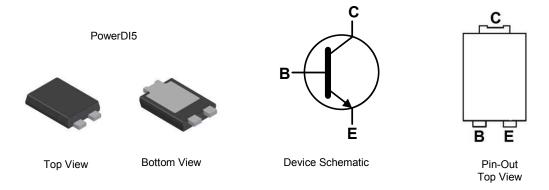
- BV_{CEO} > 100V
- I_C = 6A High Continuous Collector Current
- I_{CM} = 10A Peak Collector Current
- P_D up to 3.2W
- 43% Smaller than SOT223; 60% Smaller than TO252
- Maximum Height just 1.1mm
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: PowerDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208
- Weight: 0.093 grams (Approximate)

Applications

- Motor Drive
- Voltage Regulator Using Emitter-Follower
- DC-DC Converter
- Telecom
- Power Management



Ordering Information (Note 5)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DXT2011P5Q-13	Automotive	DXT2011	13	16	5,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

PowerDI5





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	200	V
Collector-Emitter Voltage	V _{CEO}	100	V
Emitter-Base Voltage	V _{EBO}	7	V
Continuous Collector Current	Ic	6	Α
Peak Pulse Current	Ісм	10	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit			
	(Note 6)		3.2			
Power Dissipation	(Note 7)	P_{D}	1.7	W		
	(Note 8)]	0.74			
	(Note 6)		39			
Thermal Resistance, Junction to Ambient Air	(Note 7)	$R_{ heta JA}$	R _{0JA} 75		0000	
	(Note 8)]	169	°C/W		
Thermal Resistance, Junction to Leads (Note 9)		R _{0JL}	5.6			
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C			

ESD Ratings (Note 10)

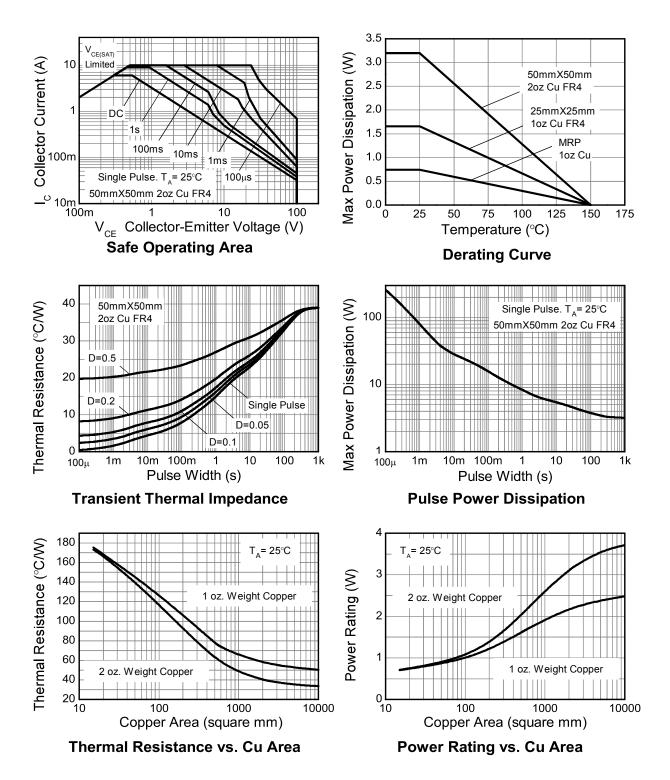
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes:

- 6. For a device mounted with the exposed collector pad on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.
- 7. Same as note (6), except mounted on 25mm x 25mm 1oz copper.
- 8. Same as note (6), except mounted on minimum recommended pad (MRP) layout.
- 9. Thermal resistance from junction to solder-point (on the exposed collector pad).
- 10. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





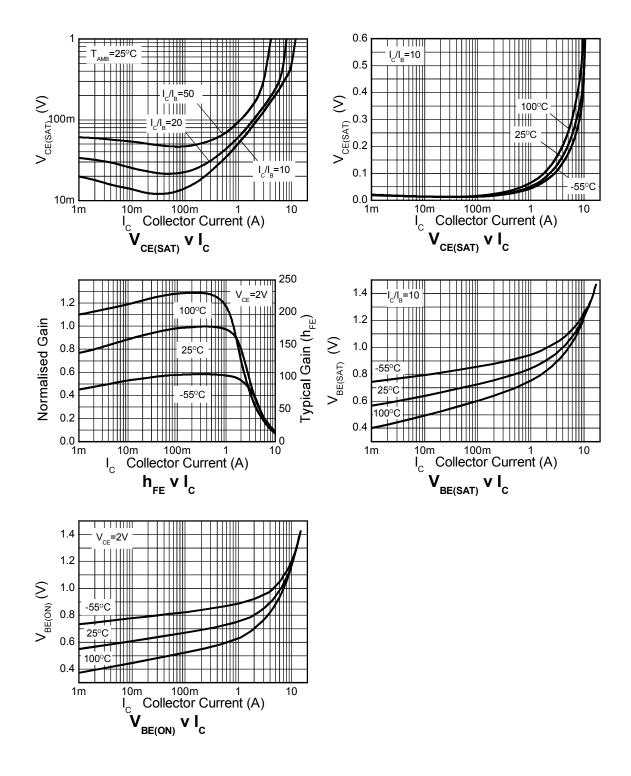
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	200	235	_	V	I _C = 100μA
Collector-Emitter Breakdown Voltage (Note 11)	BV _{CEO}	100	115	_	V	I _C = 10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	7	8.1	_	V	I _E = 100μA
Collector Cutoff Current	Ісво	1 1	1 1	20 0.5	nΑ μΑ	V _{CB} = 150V V _{CB} = 150V, T _A = +100°C
Collector Cutoff Current	l _{CER} R≤1kΩ	_		20 0.5	nΑ μΑ	V _{CB} = 150V V _{CB} = 150V, T _A = +100°C
Emitter Cutoff Current	I _{EBO}	_	_	10	nA	V _{EB} = 6V
Collector-Emitter Saturation Voltage (Note 11)	V _{CE} (SAT)		21 50 95 180	35 65 125 220	mV	$I_C = 0.1A$, $I_B = 5mA$ $I_C = 1A$, $I_B = 100mA$ $I_C = 2A$, $I_B = 100mA$ $I_C = 5A$, $I_B = 500mA$
Base-Emitter Saturation Voltage (Note 11)	V _{BE(SAT)}	_	1020	1120	mV	I _C = 5A, I _B = 500mA
Base-Emitter Turn-On Voltage (Note 11)	V _{BE(ON)}	_	920	1000	mV	V _{CE} = 2V, I _C = 5A
DC Current Gain (Note 11)	h _{FE}	100 100 30 10		300	_	$V_{CE} = 2V, I_{C} = 10mA$ $V_{CE} = 2V, I_{C} = 2A$ $V_{CE} = 2V, I_{C} = 5A$ $V_{CE} = 2V, I_{C} = 10A$
Transition Frequency	f _T	_	130	_	MHz	V _{CE} = 10V, I _C = 100mA, f = 50MHz
Output Capacitance	C _{obo}	1	26	_	pF	V _{CB} = 10V, f = 1MHz
Switching Times	t _{ON} t _{OFF}		41 1010		ns	$V_{CC} = 10V, I_C = 1A,$ $I_{B1} = -I_{B2} = 100mA$

Note: 11. Pulse Test: Pulse width \leq 300 μ s. Duty cycle \leq 2.0%.



Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

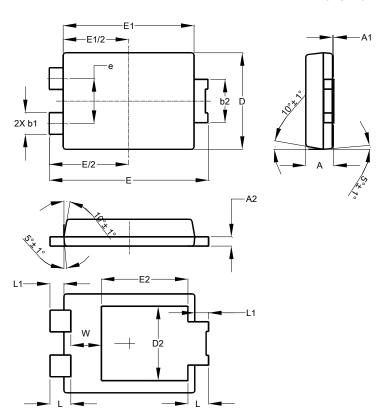




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5

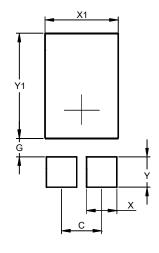


PowerDI5					
Dim	Min	Max	Тур		
Α	1.05	1.15	1.10		
A1	0.00	0.05			
A2	0.33	0.43	0.381		
b1	0.80	0.99	0.89		
b2	1.70	1.88	1.78		
D	3.90	4.05	3.966		
D2	ı	I	3.054		
Е	6.40	6.60	6.504		
е		-	1.84		
E1	5.30	5.45	5.37		
E2			3.549		
L	0.75	0.95	0.85		
L1	0.50	0.65	0.57		
W	1.10	1.41	1.255		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5



Dimensions	Value (in mm)		
С	1.840		
G	0.852		
Х	1.390		
X1	3.360		
Υ	1.400		
Y1	4.860		

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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